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29 January 2009

Ms. Susanna Kooistra
3GPP MCC
ETSI
650, route des Lucioles
06921 Sophia-Antipolis Cedex
France

Subject: Nomination of candidate for the 3GPP TSG RAN Vice-Chairman

Dear Ms. Kooistra:

I'm pleased to inform you that Qualcomm, through its ETSI 3GPP affiliation, is nominating Serge Willenegger as a candidate for one of the vice chairmanship roles in the upcoming TSG-RAN elections. Qualcomm will fully support Serge in his vice chairmanship role if elected.

Serge has been with Qualcomm since 1995. Since 1997, Serge has contributed to the design, development, and specification of the UMTS radio system; since the creation of 3GPP, he has been an active participant in 3GPP TSG RAN WG1 and TSG-RAN. Serge has been instrumental in creating, developing, and expanding Qualcomm's commitment to LTE, UMTS, and GSM systems, products, and standardization. From the beginning of Qualcomm's involvement in 3GPP until last September, Serge successfully led and continually enhanced Qualcomm's overall involvement and contribution to 3GPP. Serge continues to actively support and develop various 3GPP related initiatives within Qualcomm. Serge has the title of Vice President of Technology. Serge holds a Master in Telecommunication Sciences from the Swiss Federal Institute of Technology in Lausanne (1995).

I believe that Serge's technical skills, 3GPP experience, leadership, and personality make him ideally suited to be a RAN Vice-Chairman. He will bring solid and forward thinking leadership, while respecting the views of all participants, to further strengthen and expand

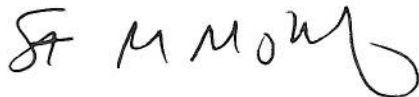
the foundation for success and growth in mobile broadband services delivered through the rapidly evolving HSPA and soon to be deployed LTE systems.

Best Regards,

A handwritten signature in black ink, appearing to read "Edward G. Tiedemann, Jr.", with a stylized flourish at the end.

Edward G. Tiedemann, Jr.
Senior Vice-President, Engineering
QUALCOMM Fellow
QUALCOMM Incorporated

I fully support Serge's nomination as 3GPP RAN Vice Chairman. I have worked closely with Serge since Qualcomm began development of our 3GPP ASIC line. Serge will bring dedication, strong leadership, technology expertise, and a tremendous understanding of the industry.

A handwritten signature in black ink, appearing to read "Steven M. Mollenkopf", with a large, sweeping flourish at the end.

Steven M. Mollenkopf
EVP & President QUALCOMM CDMA Technologies (QCT)